



#### Radiation Detector developments for low- and mediumenergy photons

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#### A.G.I.P.D.

(Adaptive Gain Integrating Pixel Detector)

- European X-FEL, Petra P01/10
- ~12keV photons
- single photon upto ~10<sup>4</sup>
   photons/pixel/frame
- 300e noise
- 1Mpixel, 200um pitch
- 4.5 Mframe/s (burst)
- hybrid Si-Si detector



#### P.E.R.C.I.V.A.L.

(Pixellated Energy Resolving Cmos Imager, Versatile And Large)

- Petra PO4, Flash, low-En synch/FELs
- 250e V ~1keV photons
- target: single photon upto 10<sup>4</sup>~10<sup>5</sup>
   photons/pixel/frame
- target: <15e noise</li>
- 10~16Mpixel, 25~27um pixel pitch
- 10-120 frame/s
- back-illuminated MAPS



#### European X-FEL



Self-Amplified Spontaneous Emission
e-accel. up to 17.5 GeV
to 200m long undulators
X-ray pulses produced 0<sup>33</sup> ph/(s mm2 mrad2 0.1%BW) peak brilliance

Non-uniform structure 2700 pulses @4.5MHz every 100ms

3.4 km long 12-44 m deep



#### Constraints





Charge integration Adaptable Gain O(2) noise ~ 0.1 photon 1Mpixel, 200 µm pitch in-pixel Memory (352)

veto schema leakage minimization rad hard design



# The A.G.I.P.D. (1assembly) AGPD



#### The A.G.I.P.D. (1boards)



#### The A.G.I.P.D. (1cooling) AGH



ASIC :  $T \le -20^{\circ}C$  (less droop post irradiation)  $\Delta T \le 5 \text{ K}$  (less spread parameters )







meanders to induce turbulent flow (better heat exchange)

plastic prototype

# The A.G.I.P.D. (1data out) AGIPD

pixels mem cell/pixel analog & gain bits/sample in 100ms

avg data rate

1M × 352 ×2 × 14 ×10 ~96.5*G*b/s

analog PCB: line reception, pickup noise filtering and digitization (@ 33MHz) 14 bits (8channels AD9257, 1 per 2 ASICs) ASICs

AD9257

x 8 AD9257s

each of the 16 module has its own "mezzanine" fast out board VIRTEX-5 FPGA: limited data sorting, pass data to 4x10 GbE outputs

data collected by data acquisition train builder card (receive, sort and reject data from the 1Mpixel camera)

## The A.G.I.P.D. (1even 2 planes) GPD



## The A.G.I.P.D. (1front sensor) AGIPD

- Si sensor p+ over n (hole collection)
- 107.6x28 mm (large monolithic sensors reduce the overall dead area)
- 500um thick
- $\rightarrow$  (>90%QE @12.4keV)
- effective entry window
   <2.5um (reasonable QE at lower energies)
- bias voltage > 500V
   (minimizes impact plasma effects)
- SINTÉF tech
- UniHH design

rad-aware design: Bd > 900V after 10MGy



#### The A.G.I.P.D. (2)





### Adaptive Gain Concept



HV I CDS gain Pixel buffer Preamp cntrl HV I CDS Pixel gain buffer Preamp

real-time adjustment of the feedback capacitance depending on the photon flux

60fF/3fF/10fF dyn. switching => adaptable gain O(2)

#### The A.G.I.P.D. (3)





#### **Command Serial IF**





#### AGIPD 1.0 status





#### former prototypes





## imaging with prototypes (AGIPD)



### irradiating ASIC prot.

Irradiation of HPAD 0.1/0.2 AGIPD03/04 chips up to 10-20-100MGy @ DORIS F4 5.4kGy/s highly accelerated irradiation rate → pessimistic estimation

- upto 10MGy: comparable behaviour, 30~40% noise increase
- 100MGy: functionality recover after annealing
- storage cell leakage (100ms): <1% at -20°C</li>



#### irradiating sensor



Irradiation AGIPD sensor up to 10MGy @ Petra P11 12keV 7.1kGy/s J. Zhang et. al.

pixel current (< 0.2 nA) saturates for doses above 1 MGy

No breakdown up to 900 V after 10 MGy (and expected for even higher doses)

C<sub>int</sub> (<150fF) weakly dependent on dose



# AGIPD at Petra P01/10 AGPD



Not in the picture: Sample, control PC, me pushing buttons, ... beamline PO1 Energy 14.4125 keV (high res. monochrom.) 192 ns/bunch triggered acquisition no sample

beamline P10 Energy 7.05 keV ~1.7x10<sup>11</sup> photons/sec, 60 bunch mode (128 ns) auto acquisition 200ns &192 ns integr. 2 samples: SiO2 particles in liquid (100 & 250 nm radius)



#### AGIPD at Petra P10



#### beam stopper



#### imaging the direct beam







#### AGIPD at Petra P10

10<sup>12</sup>





106

photon/second/pixel

 $10^{7}$ 

104

105



X-ray Photon Correlation Spectroscopy exp. results comparable to estab. detectors extending the range

(no beam stop  $\rightarrow$  nearer to beam center)



#### AGIPD at Petra P01







used to perform measurements of intensity correlations in the beam

High order interferometry of single storage ring pulses measured by AGIP detector A. Singer, I. A. Vartanyants et al. [subm for pubbl.] through 150um slit









#### What about lower energy photons?





#### **Percival: Motivation**







Challenge below 1keV: sub-um absorption lengths





Monolithic: Collecting diodes & readout circuitry share the same substrate Fast rise in the last ~10 yrs, today the common technology in digital cameras. Using standard industrial CMOS processes

Gain from industry developments, shrinking feature sizes, ...

Limitations imposed by commercial foundries: epilayer thickness, V constraints



#### The P.E.R.C.I.V.A.L.(1)



P<sup>E</sup>RCIVAL

#### multiple gains: a different approach





The P.E.R.C.I.V.A.L.(2)

10~16M pixels slow controlPC x 15 bit/pixel x 2 (double samplig) ddress x 120 frame/s 36~58 Gbit/s Ø **FPGA** out gital double sampling (of reset level & integrated signal) ADC possibility of streaming out only one [the most sampling upto 120 frame/s suitable] of the multiple & gain selection reading of integrated signal (+2 sel. bits)

PRCIVAL

#### Percival Prototype (1)





#### Percival Prototype (2)





#### Front-illuminated limits









intrinsic limit: much charge will not be properly collected by photodiodes

backthinned prototypes for back-illumination to be ready ~end of the year



#### imaging with prototype



H H H P F

"P" laser-printed on transparent foil, mounted on circular sample holder interposed between the sensor and a white-light LED.





Image: det is the set of the

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Vertical "stripes" due to differing metal layers modulating the incident light in front-illumination.

6 different pixel types -> different responses





me<sup>pushing</sup>

beamline 04 Energy 300eV-2keV 10<sup>9</sup>~10<sup>13</sup>photons/sec

used parasitically (downstream gas detectors)

beamline: 193ns/bunch we: took it slow: 17 frame/s

























#### A.G.I.P.D.

- 1Mpixel, 200um pitch
- ~12keV photons [ 7~14 tested ]
- single photon upto ~10<sup>4</sup>
   photons/pixel/frame
- 300e noise: tested
- 4.5 Mframe/s (burst): tested 5.2
- Single chip assemblies: in a few weeks
- First 1M system: beginning 2015



#### P.E.R.C.I.V.A.L.

- prototype ~33kpixel 25um
- preliminary test on frontilluminated samples 900eV~2keV
- Back-thinned test structures end of 2013 → soft X-ray testing (250eV~1keV photons)
- Full sensor [10~16Mpixel, 25~27um pixel pitch] tape-out 2014
- First full, back-thinned sensor ready for X-rays 2015







# backup





## The A.G.I.P.D. (1data out) AG

pixels mem cell/pixel analog & gain bits/sample in 100ms

x 352 x2 x 14 x10

1M

avg data rate ~96.5Gb/s

then why 16 mezzanines, each with 4x10Gb/s outs?

common development with other projects

limited FPGA memory per mezzanine (resorting)

ADC out/module 8 x 8 sampled at x 33Mhz bits/sample x 14

burst data rate ~29.5Gb/s per module



### irradiating ASIC (2)



first irradiation attempts (ASIC on FR-4) gave us troubles:

12-24h after (~10MGy) chip irradiation, FR-4 begins to sprout bubble of liquid.

if one of said bubbles forms under a wire-bond pad, the wirebond (on the FR4) fails

summary: use ceramics















